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## CLAIMS

- 1. A sensing device for sensing a specific binding between an analyte and a recognition molecule, comprising a sensor with a micro-electronically addressable sensor surface comprising an individually addressable thermal or electrochemical activation element arranged to activate said sensor surface and a recognition molecule bound to said sensor surface by at least a thermal or electrochemical activation step, wherein said sensor is arranged to sense a specific binding between said recognition molecule and an analyte.
  - 2. The sensing device as in claim 1 comprising a plurality of micro-electronically individually addressable sensor surfaces, each sensor surfaces being individually activatable.
  - 3. The sensing device as in claim 1 or 2 comprising a plurality of micro-electronically individually addressable sensors.
- 4. The sensing device of any of the claims 1 20 to 3 wherein the sensor surface comprises an anchoring layer.

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- 5. The sensing device of claim 4 wherein the anchoring layer is selected from the group consisting of chemical molecules or a metal layer.
- 6. The sensing device of claim 4 or 5 wherein the anchoring layer is activatable by thermal or electrochemical actuation.
  - 7. The sensing device of any of the preceding claims 1 to 6, wherein said activation element is an electrochemical activation element.
  - 8. The sensing device of claim 7 wherein the sensor surface comprising a surface layer, the surface layer comprising a material arranged to allow electrontransfer over said surface layer.

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- 9. The sensing device according to claim 8 wherein the material of said surface layer is selected from the group consisting of metals, thin oxides, semiconductors and organic layer.
- 5 10. The sensing device of any of the preceding claims 1 to 7, wherein said activation element is a thermal activation element.
- 11. The sensing device according to claim 10 wherein said thermal activation element is selected from10 the group consisting of resistor, a microwave-heatable element and a peltier element.
  - 12. The sensing device according to claim 10 or 11, wherein each individual sensor surface is thermally isolated from heat fluxes from neighbouring sensor surfaces.
- 13. The use of a microelectronic device for localised/patterned deposition and/or desorption of (bio)molecules onto the surface of a device using addressable microelectronic structures, whereby adsorption or deposition and/or desorption of (bio)molecules on said surface is obtained via thermal and/or electrochemical spotting.
  - **14.** The use of a device for localised/patterned deposition and/or desorption of (bio) molecules onto the surface of a device addressable structures wherein the adsorption of deposition and/or desorption if (bio)molecules on said surface is obtained via thermal and/or electrochemical spotting.
- 15. A method for sensing a binding event,
  30 said method comprising the following steps:
  - Providing a sensing device such as in any of the claims 1 to 12,
  - Activating the sensor surface,

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- Depositing recognition molecules from a liquid or vapour phase,
- Detecting a binding event between said recognition molecule and an analyte.
- 5 16. A method for depositing molecules onto a surface, said method comprising the following steps:
  - Providing a device, said device comprising a plurality of surfaces wherein at least one surface is individually thermally activatable
- 10 Activating the at least one surface,
  - Depositing molecules onto the at least one surface
  - 17. A method as recited in claim 16 further comprising the step of selecting at least one surface followed by the activation step.
- 18. A method as recited in claim 16 wherein the device is a micro-electronic chip.
  - 19. A method as recited in claim 16 wherein the activation step is activation by laser light.
- 20. A method as recited in claim 16 wherein 20 said device further comprise an individually thermally activatable micro-electronic structure for activating the at least one surface.